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September 2016

#### FDMS10C4D2N

## N-Channel Shielded Gate PowerTrench<sup>®</sup> MOSFET 100 V, 124 A, 4.2 m $\Omega$

#### **Features**

- Shielded Gate MOSFET Technology
- Max  $r_{DS(on)} = 4.2 \text{ m}\Omega$  at  $V_{GS} = 10 \text{ V}$ ,  $I_D = 44 \text{ A}$
- Max  $r_{DS(on)} = 14 \text{ m}\Omega$  at  $V_{GS} = 6 \text{ V}$ ,  $I_D = 22 \text{ A}$
- ADD
- 50% lower Qrr than other MOSFET suppliers
- Lowers switching noise/EMI
- MSL1 robust package design
- 100% UIL tested
- RoHS Compliant

#### **General Description**

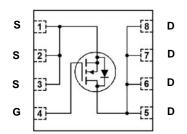
This N-Channel MV MOSFET is produced using Fairchild Semiconductor's advanced PowerTrench® process that incorporates Shielded Gate technology. This process has been optimized to minimise on-state resistance and yet maintain superior switching performance with best in class soft body diode.

#### **Applications**

- Industrial Motor Drive
- Industrial Power Supply
- Industrial Automation
- Battery Operated Tools
- Battery Protection
- Solar Inverters
- UPS and Energy Inverters
- Energy Storage
- Load Switch







### **MOSFET Maximum Ratings** $T_A = 25$ °C unless otherwise noted

Symbol	Param	eter		Ratings	Units	
$V_{DS}$	Drain to Source Voltage			100	V	
$V_{GS}$	Gate to Source Voltage			±20	V	
	Drain Current -Continuous	T <sub>C</sub> = 25 °C	(Note 5)	124		
	-Continuous	T <sub>C</sub> = 100 °C	(Note 5)	78		
ID	-Continuous	T <sub>A</sub> = 25 °C	(Note 1a)	17	A	
	-Pulsed		(Note 4)	510		
E <sub>AS</sub>	Single Pulse Avalanche Energy		(Note 3)	337	mJ	
P <sub>D</sub>	Power Dissipation	T <sub>C</sub> = 25 °C		125	W	
	Power Dissipation	T <sub>A</sub> = 25 °C	(Note 1a)	2.5	VV	
Ti. Teta	Operating and Storage Junction Tempera	ature Range		-55 to +150	°C	

#### **Thermal Characteristics**

R	JC	Thermal Resistance, Junction to Case	1.0	°C/W
R	ЭJA	Thermal Resistance, Junction to Ambient (Note 1a)	50	C/VV

#### **Package Marking and Ordering Information**

Device Markin	g Device	Package	Reel Size	Tape Width	Quantity
FDMS10C4D2I	N FDMS10C4E	D2N Power 56	13 "	12 mm	3000 units

#### Electrical Characteristics T<sub>J</sub> = 25 °C unless otherwise noted

Parameter

Off Characteristics								
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} = 0 V$	100			V		
$\Delta BV_{DSS} \over \Delta T_{J}$	Breakdown Voltage Temperature Coefficient	$I_D$ = 250 $\mu$ A, referenced to 25 °C		60		mV/°C		
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 80 V, V <sub>GS</sub> = 0 V			1	μА		
I <sub>GSS</sub>	Gate to Source Leakage Current	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$			100	nA		

**Test Conditions** 

Min

Max

Тур

Units

#### On Characteristics

**Symbol** 

$V_{GS(th)}$	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \mu A$	2.0	3.1	4.0	V
$\Delta V_{GS(th)} \over \Delta T_J$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D$ = 250 $\mu$ A, referenced to 25 °C		-9		mV/°C
		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 44 A		3.3	4.2	
r <sub>DS(on)</sub>	Static Drain to Source On Resistance	$V_{GS} = 6 \text{ V}, I_D = 22 \text{ A}$		5.3	14	mΩ
, ,		$V_{GS} = 10 \text{ V}, I_D = 44 \text{ A}, T_J = 125 \text{ °C}$		5.7	9.0	
g <sub>FS</sub>	Forward Transconductance	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 44 A		116		S

#### **Dynamic Characteristics**

C <sub>iss</sub>	Input Capacitance	V 50 V V 0 V		2945	4500	pF
C <sub>oss</sub>	Output Capacitance	$V_{DS} = 50 \text{ V}, V_{GS} = 0 \text{ V},$ f = 1  MHz		1730	2600	pF
C <sub>rss</sub>	Reverse Transfer Capacitance	1 - 1 1011 12		20	50	pF
$R_g$	Gate Resistance		0.1	1.3	2.6	Ω

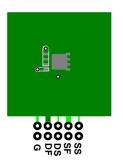
#### **Switching Characteristics**

t <sub>d(on)</sub>	Turn-On Delay Time		17	31	ns
t <sub>r</sub>	Rise Time	V <sub>DD</sub> = 50 V, I <sub>D</sub> = 44 A,	9	18	ns
t <sub>d(off)</sub>	Turn-Off Delay Time	$V_{GS} = 10 \text{ V}, R_{GEN} = 6 \Omega$	25	40	ns
t <sub>f</sub>	Fall Time		6	12	ns
$Q_{g}$	Total Gate Charge	V <sub>GS</sub> = 0 V to 10 V	42	65	nC
$Q_g$	Total Gate Charge	$V_{GS} = 0 \text{ V to 6 V}$ $V_{DD} = 50 \text{ V},$	27	43	nC
$Q_{gs}$	Gate to Source Charge	I <sub>D</sub> = 44 A	13		nC
$Q_{ad}$	Gate to Drain "Miller" Charge		9.3		nC

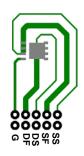
#### **Drain-Source Diode Characteristics**

V <sub>SD</sub>	Source to Drain Diode Forward Voltage	$V_{GS} = 0 \text{ V}, I_S = 2.1 \text{ A}$ (Note 2)	0.7	1.2	\/
	Source to Drain blode Polward voltage	$V_{GS} = 0 \text{ V}, I_{S} = 44 \text{ A}$ (Note 2)	0.8	1.3	V
t <sub>rr</sub>	Reverse Recovery Time	I <sub>F</sub> = 20 A, di/dt = 300 A/μs	32	52	ns
Q <sub>rr</sub>	Reverse Recovery Charge	-1F = 20 A, α//αί = 300 A/μs	57	92	nC
t <sub>rr</sub>	Reverse Recovery Time	I <sub>F</sub> = 20 A, di/dt = 1000 A/μs	25	40	ns
Q <sub>rr</sub>	Reverse Recovery Charge	- I <sub>F</sub> = 20 A, α//αι = 1000 A/μs	158	253	nC

<sup>1.</sup> R<sub>0JA</sub> is determined with the device mounted on a 1 in<sup>2</sup> pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. R<sub>0CA</sub> is determined by the user's board design.



a) 50 °C/W when mounted on a 1 in<sup>2</sup> pad of 2 oz copper



b) 125 °C/W when mounted on a minimum pad of 2 oz copper.

<sup>2.</sup> Pulse Test: Pulse Width < 300  $\mu$ s, Duty cycle < 2.0%. 3. E<sub>AS</sub> of 337 mJ is based on starting T<sub>J</sub> = 25 °C; N-ch: L = 3 mH, I<sub>AS</sub> = 15 A, V<sub>DD</sub> = 100 V, V<sub>GS</sub> =10 V. 100% test at L = 0.1 mH, I<sub>AS</sub> = 49 A. 4. Pulsed ld please refer to Fig 11 SOA graph for more details.

<sup>5.</sup> Computed continuous current limited to Max Junction Temperature only, actual continuous current will be limited by thermal & electro-mechanical application board design.

#### Typical Characteristics T<sub>J</sub> = 25 °C unless otherwise noted

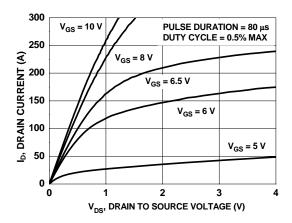


Figure 1. On-Region Characteristics

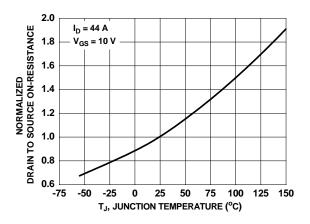


Figure 3. Normalized On-Resistance vs Junction Temperature

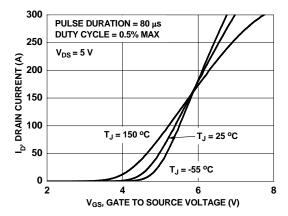


Figure 5. Transfer Characteristics

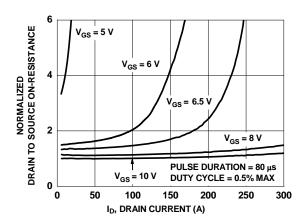


Figure 2. Normalized On-Resistance vs Drain Current and Gate Voltage

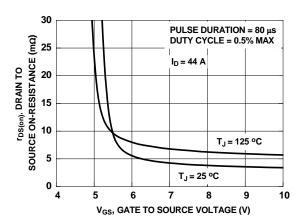


Figure 4. On-Resistance vs Gate to Source Voltage

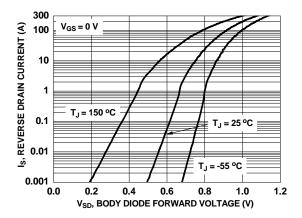


Figure 6. Source to Drain Diode Forward Voltage vs Source Current

#### **Typical Characteristics** $T_J = 25$ °C unless otherwise noted

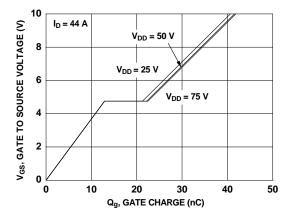


Figure 7. Gate Charge Characteristics

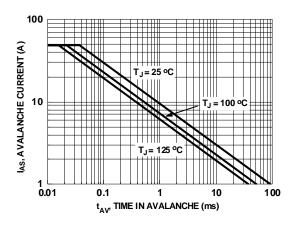


Figure 9. Unclamped Inductive Switching Capability

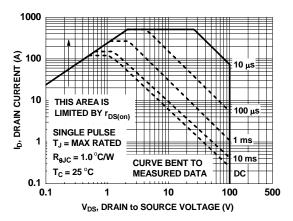


Figure 11. Forward Bias Safe Operating Area

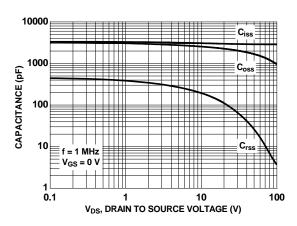


Figure 8. Capacitance vs Drain to Source Voltage

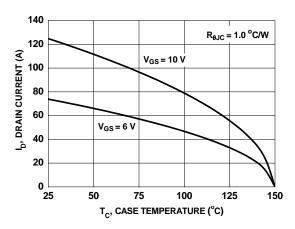


Figure 10. Maximum Continuous Drain Current vs Case Temperature

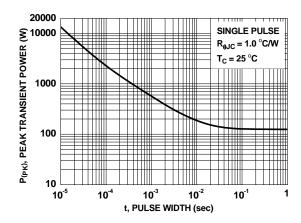


Figure 12. Single Pulse Maximum Power Dissipation



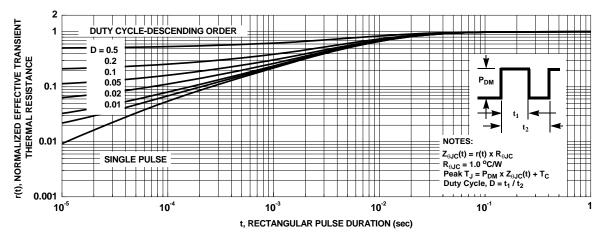
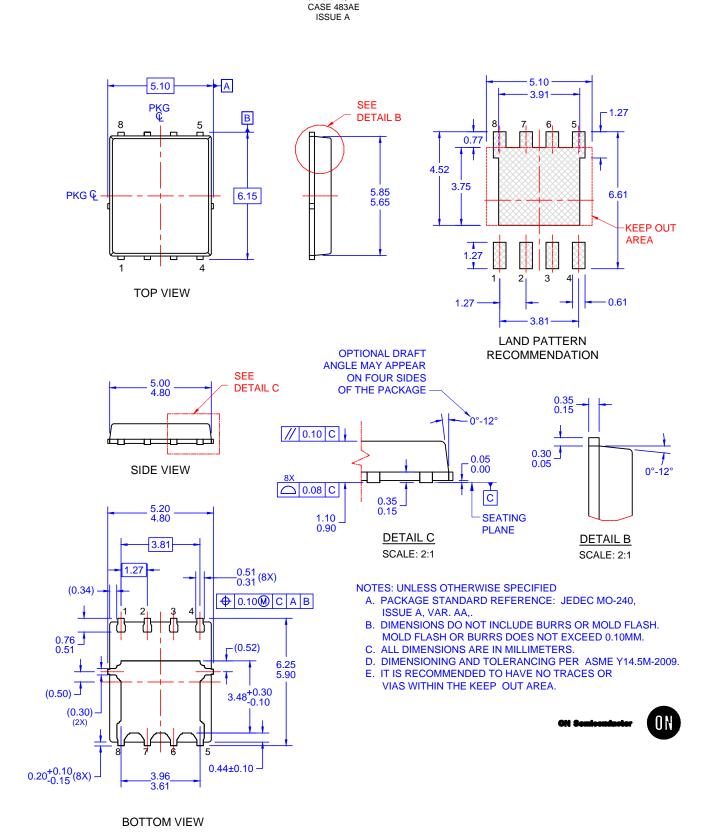


Figure 13. Junction-to-Case Transient Thermal Response Curve



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